



**SPECIFICATION
FOR
LCM Module
KD028QVFMA017-RT**

MODULE:	KD028QVFMA017-RT
CUSTOMER:	

REV	DESCRIPTION	DATE
1.0	FIRST ISSUE	2017.06.07
1.1	Modify LCM Luminance	2017.06.13

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

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支持小量
NO MOQ

品种齐全
In Full Range

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*** Description**

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 2.8'TFT-LCD contains 240x320 pixels, and can display up to 65K/262K colors.

*** Features**

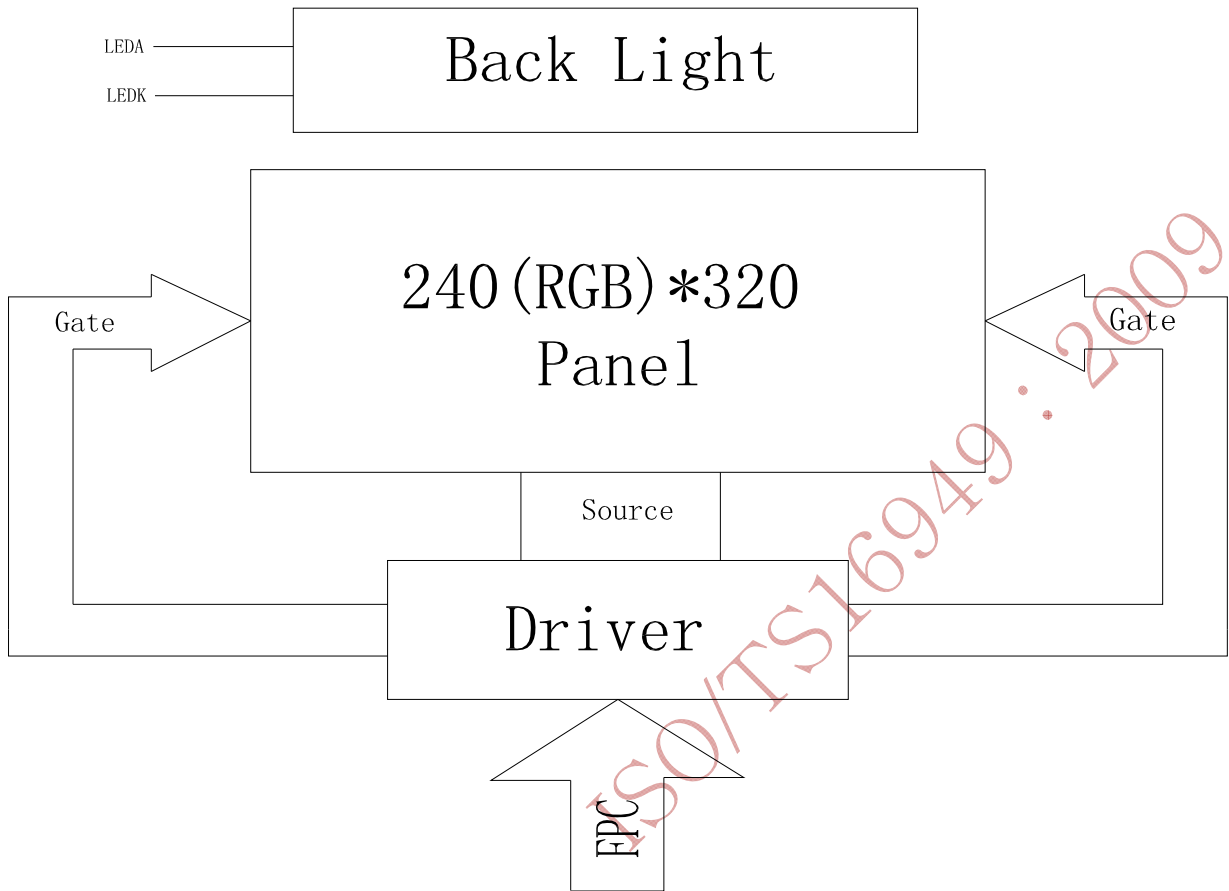
- Low Input Voltage: 3.3V(TYP)
- Display Colors of TFT LCD: 65K/262K colors
- TFT Interface: 8/9/16/18Bit MCU Interface
3/4SPI+16/18Bit RGB Interface
3-line/4-line Serial Interface

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	43.20(H)*57.60 (V) (2.8inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65K/262k	colors	-
Number of pixels	240(RGB)*320	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.180(H)*0.180(V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	ST7789V	-	-
Display mode	Transmissive/ Normally black	-	-
Operating temperature	-20~+70	°C	-
Storage temperature	-30~+80	°C	-

*** Mechanical Information**

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		50.50		mm	-
	Vertical(V)		69.70		mm	-
	Depth(D)		3.8		mm	-
Weight			TBD		g	-

1. Block Diagram



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2. Outline dimension

Dimensions:
 50.50±0.2 IP BEZEL
 80.10±0.2 TP-00
 2.65
 44.20 TP-AA
 43.20 LCD-AA
 3.15
 3.65
 2.91
 2.41
 69.70±0.2 UP BEZEL
 68.00 TP-VA
 59.60 TP-VA
 58.60 TP-AA
 57.60 LCD-AA
 2.8 TFT
 2.40*RRP*320 IPS
 47.39±0.5
 12.50±0.5
 0.20
 3.50±0.3
 P=0.24*P=24.80±0.05
 25.50±0.1
 W=0.30±0.03
 29.12
 15.67
 0.13
 3.80±0.2
 2.60 LCM
 FRONT
 BACK
 CONTACT SIDE
 P1#增强
 0.30±0.03
 5.00
 3.50
 6.10
 23.50
 21.12
 1.02
 丝印对位线
 BL0280601
 FZ+X X X 日
 BL0280601
 FZ+X X X 日
 45.09±0.5
 0.80 MAX

NOTES:
 1. DISPLAY TYPE: 2.8", TFT-LCD, 65K/262K COLORS
 2. DISPLAY MODE: IPS NORMALLY BLACK
 3. VIEWING DIRECTION: ALL
 4. DRIVER IC: SIT789V (00G)
 5. VCI: 3.3V
 6. OPERATING TEMP: -20° C TO 70° C
 STORAGE TEMP: -30° C TO 80° C
 7. BACK LIGHT: LED WHITE, 6 LED, 120mA, 3.2±0.3V
 8. ROHS COMPLIANT.

RGB Interface
 K1(-)
 K2(-)
 K3(-)
 K4(-)
 K5(-)
 K6(-)
 A(+)
 YU
 X1
 YD
 XR
 1
 2
 3
 4
 走线示意图
 BLU CIRCUIT DIAGRAM

PCB展开出货
 NOTE: MCU Interface SET for IM PINS.

NO	IN	NO	Interface type	IM Pin in use
0	0	0	IM Tps, 16bit Interface	DB17-DB10, DB8-DB1
0	0	1	IM Tps, 8bit Interface	DB17-DB10
0	1	0	IM Tps, 8bit Interface	DB17-DB8
0	1	1	IM Tps, 8bit Interface	DB17-DB9
0	1	1	3-File 9 Bit data serial Interface	S0A, SCL, CS
1	1	0	9-bit 8 BIT data serial Interface	S0A, SCL, CS, RS

 NOTE: If not use PINS fix to the GND, 10VCC or NC.

PCB折参考图
 FPC展开出货

REVISION HISTORY

Rev	Revision content description	Date
V0	FIRST	2016/09/04

深圳市柯达科电子科技有限公司
 SHEENZHEN STARTEK ELECTRONICS CO., LTD

DRAWING NAME KD028QVFMA017-TP
PARIS NO. 99028020B
TOLERANCE X.X±0.3
OPERATING TEMPERATURE X.XX±0.2
 Scale 1:1
 Checked
 Drawn
 Approve

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3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	XR(NC)	Touch panel Right Glass Terminal	A/D
3	YD(NC)	Touch panel Bottom Film Terminal	A/D
4	XL(NC)	Touch panel LIFT Glass Terminal	A/D
5	YU(NC)	Touch panel Top Film Terminal	A/D
6	IOVCC	Supply voltage for IO (1.8-3.3V).	P
7	IOVCC	Supply voltage for IO (1.8-3.3V).	P
8	VCI	Supply voltage (3.3V).	P
9	VCI	Supply voltage (3.3V).	P
10	IM2	MPU Parallel interface bus and serial interface select If use RGB Interface must select serial interface. Fix this pin at IOVCC and GND.	I
11	IM1		
12	IM0		
13	RESET	This signal will reset the device and must be applied to properly initialize the chip.	I
14	CS	Chip select input pin ("Low" enable). Fix this pin at IOVCC or GND when not in use.	I
15	RS(SPI-SCL)	This pin is used to select "Data or Command" in the parallel interface. When D/CX = '1', data is selected. When D/CX = '0', command is selected. This pin is used serial interface clock in 3-wire 9-bit / 4-wire 8-bit serial data interface. Fix this pin at IOVCC or GND when not in use.	I
16	WR(SPI-RS)	The data is applied on the rising edge of the SCL signal. Fix this pin at IOVCC or GND when not in use.	I
17	RD	Serves as a read signal and MCU read data at the rising edge. Fix this pin at IOVCC or GND when not in use	I
18	VSYNC	Frame synchronizing signal for RGB interface operation. Fix this pin at IOVCC or GND when not in use.	I
19	HSYNC	Line synchronizing signal for RGB interface operation. Fix this pin at IOVCC or GND when not in use.	I

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20	ENABLE	Data enable signal for RGB interface operation. Fix this pin at IOVCC or GND when not in use.	I
21	DOTCLK	Dot clock signal for RGB interface operation. Fix this pin at IOVCC or GND when not in use.	I
22	SDA	Serial input signal. The data is applied on the rising edge of the SCL signal. If not used, fix this pin at IOVCC or GND.	I
23-40	DB0-DB17	Data bus. If not used pin, fix this pin to GND.	I/O
41	SDO	SPI interface output pin. -The data is output on the falling edge of the SCL signal. -If not used, let this pin open.	O
42	GND	Ground.	P
43	LEDA	Anode pin of backlight	P
44	LEDK1	Cathode pin OF backlight	P
45	LEDK2	Cathode pin OF backlight	P
46	LEDK3	Cathode pin OF backlight	P
47	LEDK4	Cathode pin OF backlight	P
48	LEDK5	Cathode pin OF backlight	P
49	LEDK6	Cathode pin OF backlight	P
50	GND	Ground.	P

ISO9001:2008 ISO/TS16949:2009

4. LCD Optical Characteristics

4.1 Optical specification

Item	Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio	CR	$\Theta=0$	600	800			
Response time	Rising	T_{R+T_F}	--	30	40	msec	(1)(2)
	Falling						
Color gamut	S(%)		--	60	--	%	(1)(3)
Color Filter Chromaticity	White	W_X	0.268	0.308	0.348		(1)(4) CF glass
		W_Y	0.288	0.328	0.368		
	Red	R_X	0.613	0.633	0.653		
		R_Y	0.325	0.345	0.365		
	Green	G_X	0.311	0.331	0.351		
		G_Y	0.600	0.620	0.640		
	Blue	B_X	0.125	0.145	0.165		
		B_Y	0.048	0.068	0.088		
Viewing angle	Hor.	Θ_L	--	80	--		(1)(4) Measuring with Polarizer Reference Only
		Θ_R	--	80	--		
	Ver.	Θ_U	--	80	--		
		Θ_D	--	80	--		
Option View Direction			Free				(5)

4.2 Measuring Condition

- Measuring surrounding: dark room
- Ambient temperature: $25 \pm 2^\circ\text{C}$
- 15min. warm-up time.

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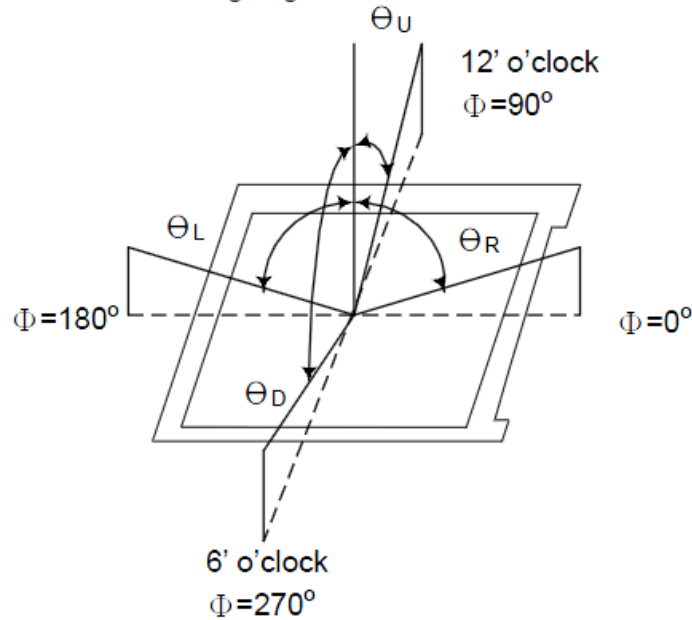
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4.3 Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

Note (1) Definition of Viewing Angle:

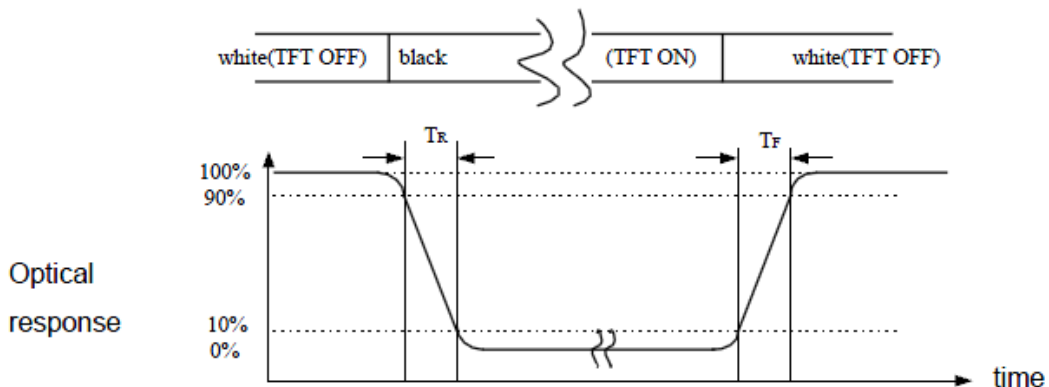


Note (2) Definition of Contrast Ratio (CR) :

measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3) Definition of Response Time : Sum of T_R and T_F



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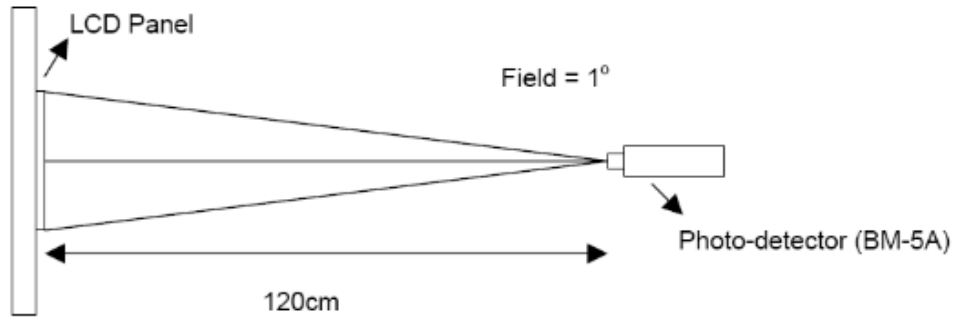
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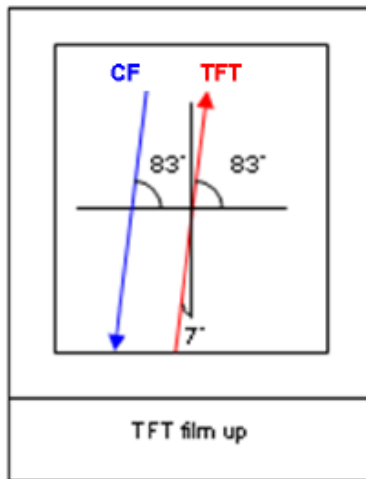
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Note (4) Definition of optical measurement setup



Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.)



ISO9000

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In Full Range

5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VCI	-0.3	4.6	V
Digital interface supply Voltage	IOVCC	-0.3	4.6	V
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VCI	2.4	2.8	3.3	V	
Digital interface supply Voltage	IOVCC	1.65	1.8	3.3	V	
Normal mode Current consumption	IDD	--	6.8	--	mA	
Level input voltage	V _{IH}	0.7V _{DDIO}		V _{DDIO}	V	
	V _{IL}	GND		0.3V _{DDIO}	V	
Level output voltage	V _{OH}	0.8V _{DDIO}		V _{DDIO}	V	
	V _{OL}	GND		0.2V _{DDIO}	V	

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5.3 LED Backlight Characteristics

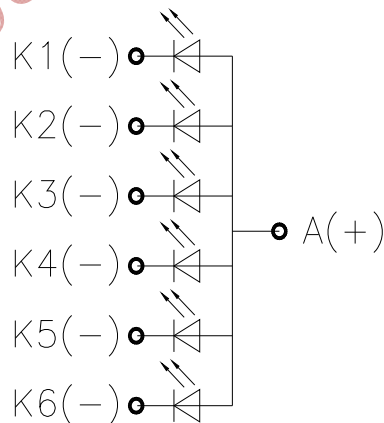
The back-light system is edge-lighting type with 6 chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	90	120	--	mA	
Forward Voltage	V_F	--	3.2	--	V	
LCM Luminance	L_v	510	560	--	cd/m ²	Note3
LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	AVg	80	--	--	%	Note3

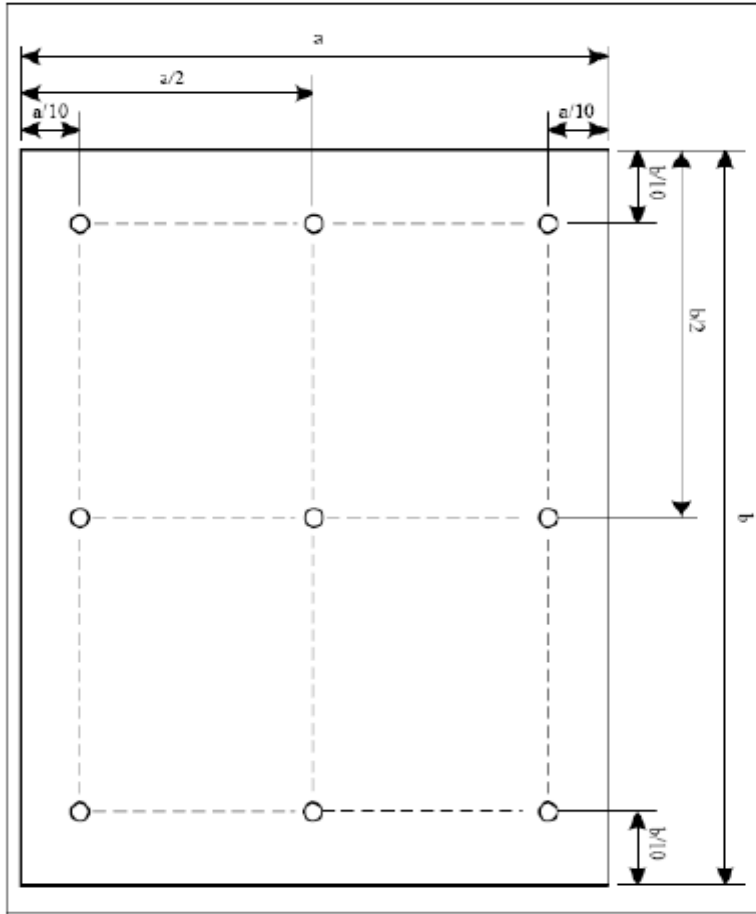
Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

$T_a=25\pm 3\text{ }^\circ\text{C}$, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at $T_a=25\text{ }^\circ\text{C}$ and $I_L=120\text{mA}$. The LED lifetime could be decreased if operating I_L is larger than 120mA. The constant current driving method is suggested.



NOTE 3: Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

ISO9001

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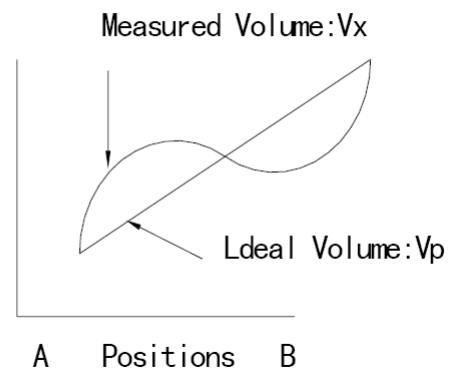
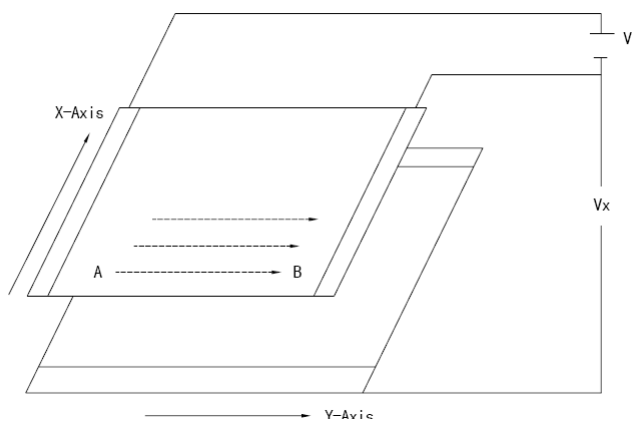
6. TP Feature

6.1 Conditions of use and storage

Item	Value(condition)	Note
Temperature range upon operation	Humidity: 20%~90% non dew, condensation -20°C~70°C	In a simple substance
Temperature range upon storage	Humidity: 20%~90% non dew, condensation -30°C~80°C	In a simple substance

6.2 Electrical property

Item	Value	Note
Maximum voltage	DC5V	
Resistance between terminals	X direction[Film side]:200-600Ω Y direction [Glass side]:300-900Ω	
Insulation resistance	DC 25V 20MΩor above	Connect X + ~X- and Y+ ~Y-, apply 25VDC Between X and Y for perform measurements
Chattering	10 msec or below	
Rating	Voltage is DC 5V	



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6.3 Mechanical property

Item	Performance		Note
Input method	Used of an exclusive pen or finger		
Load upon operation	Exclusive pen	60-100g or below	Operation and measurement with a pen must be carried out under the following tip condition s: Stylus pen material : POM(ployacetal) . Tip : Diameter 3.0mm, SR 0.8 mm
	Finger	60-100g or below	Operations and measurement methods simulate d for a finger must be carried out under the fo llowing tip conditions. Material :Silicon rubber (Hardness : 30°Hs) Tip : Diameter 12.0 mm, SR 12.5mm
Surface hardness	Pencil hardness : 3H or above		It complies with the way of test method JIS K5400.

6.4 Optical property

Item	Performance	Note
Total light transmittance	80% or above	JIS K7105
Haze	5% or below	JIS K7136
Film specification	Polished type with hard coated surface	

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7. AC Characteristic

7.1 8080 Series MCU Parallel Interface Timing Characteristics: 18/16/9/8-bit Bus

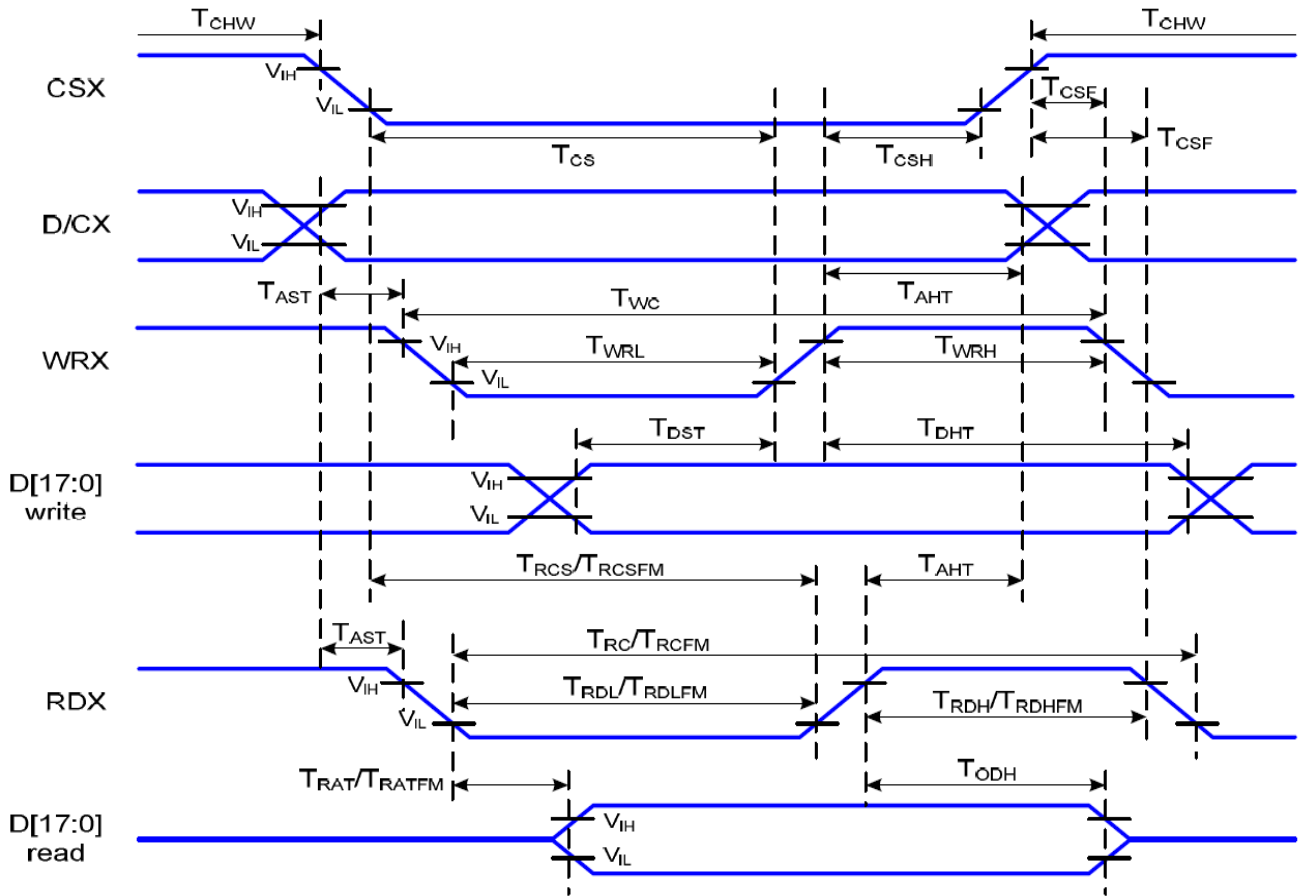


Figure6-1-1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

$V_{DDI}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30$ to $70\text{ }^{\circ}C$

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	

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	T_{WRH}	Control pulse "H" duration	15		ns	
	T_{WRL}	Control pulse "L" duration	15		ns	
RDX(ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX(FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration(FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration(FM)	355		ns	
DB[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF
	T_{DHT}	Data hold time	10		ns	
	T_{RAT}	Read access time (ID)		40	ns	
	T_{RATFM}	Read access time (FM)		340	ns	
	T_{ODH}	Output disable time	20	80	ns	

Table6-1-1 8080 Parallel Interface Characteristics

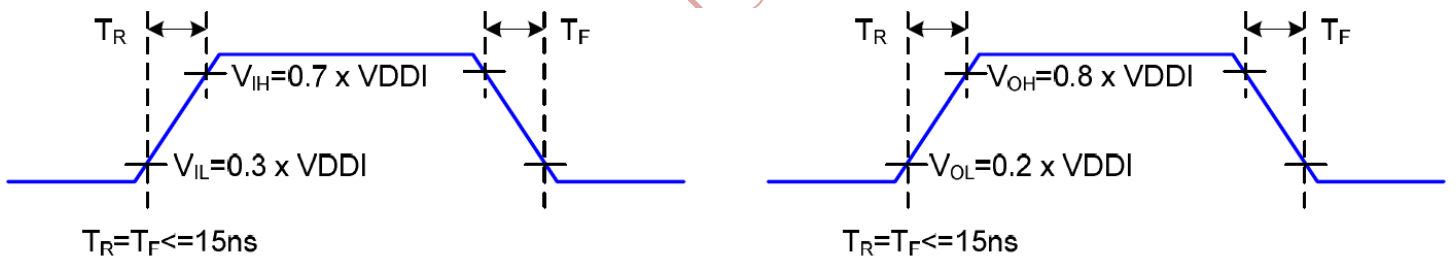


Figure6-1-2 Rising and Falling Timing for I/O Signal

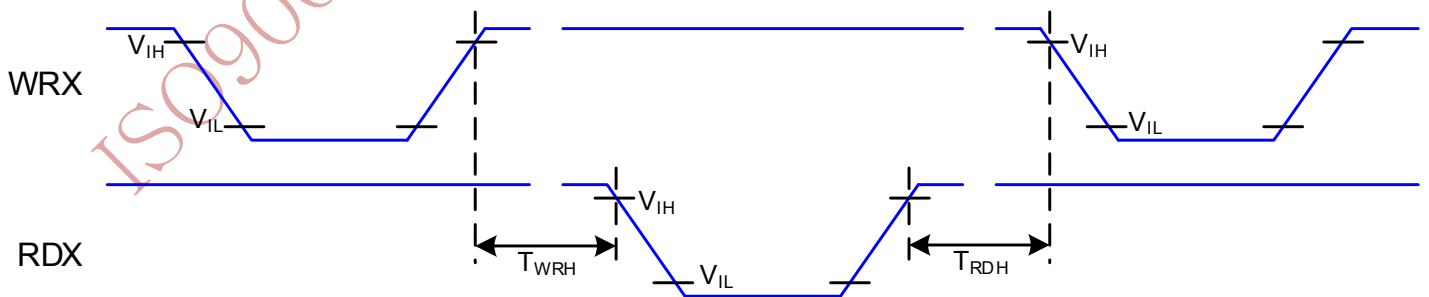


Figure6-1-3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (T_r , T_f) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

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7.2 Display Serial Interface Timing Characteristics (3-line SPI system)

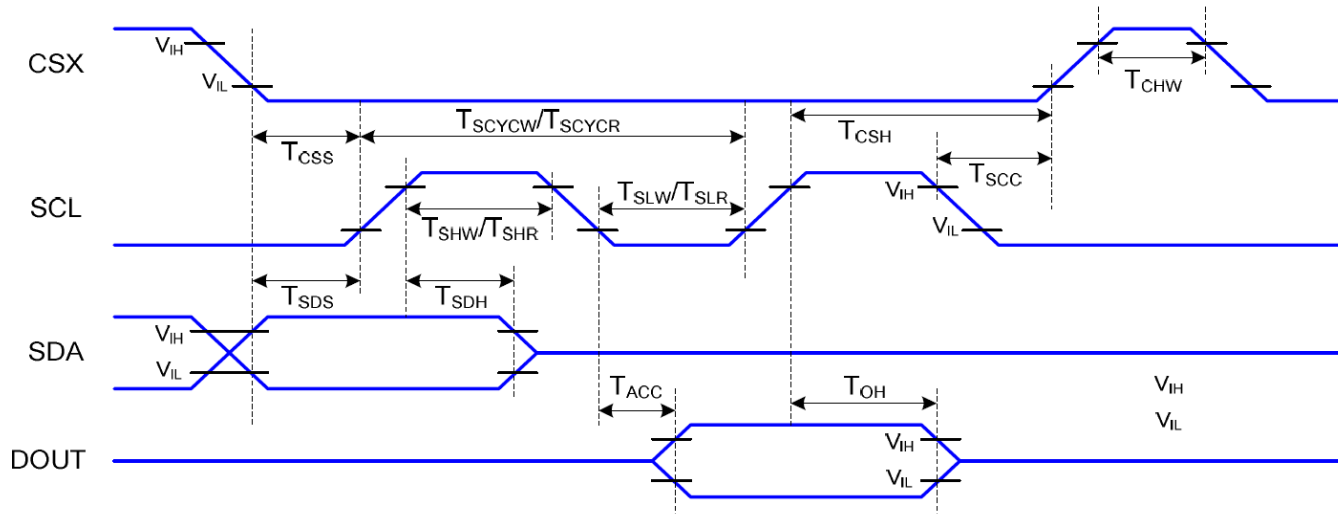


Figure6-2-1 3-line serial Interface Timing Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 °C

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T _{CSS}	Chip select setup time (Write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
SCL	T _{SCYCW}	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
	T _{SLW}	SCL "L" pulse width (Write)	15		ns	
	T _{SCYCR}	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T _{SDS}	Data setup time	10		ns	
	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T _{OH}	Output disable time	15	50	ns	For minimum CL=8pF

Table6-2-1 3-line serial Interface Characteristics

Note: The rising time and falling time (T_r , T_f) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

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常备库存
Stock For Sale

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Long Time supply

支持小量
NO MOQ

品种齐全
In Full Range

7.3 Display Serial Interface Timing Characteristics (4-line SPI system)

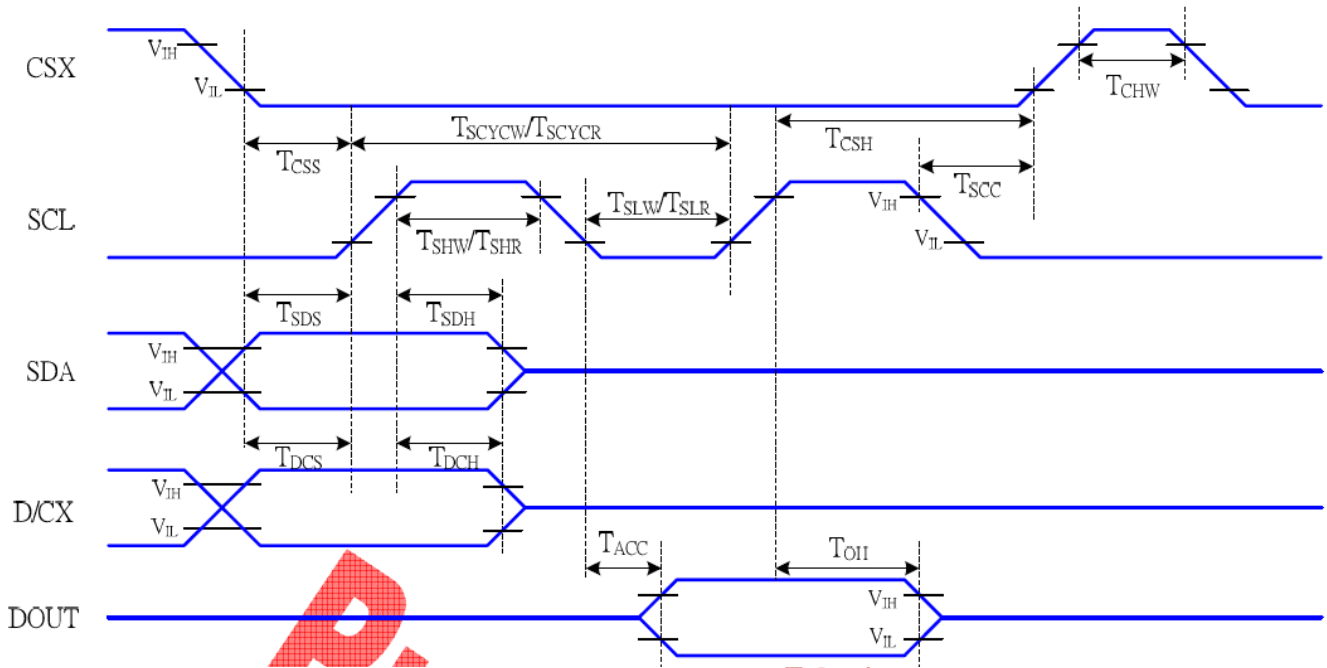


Figure6-3-1 4-line serial Interface Timing Characteristics

$V_{DDI}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30$ to 70 °C

Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (Write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCH}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data ram
	T_{SHW}	SCL "H" pulse width (Write)	15		ns	
	T_{SLW}	SCL "L" pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T_{DCS}	D/CX setup time	10		Ns	
	T_{DCH}	D/CX hold time	10		ns	
SDA	T_{SDS}	Data setup time	10		ns	

(DIN)	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T _{OH}	Output disable time	15	50	ns	For minimum CL=8pF

Table6-2-1 4-line serial Interface Characteristics

Note: The rising time and falling time (T_r , T_f) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

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NO MOQ

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7.4 Parallel RGB Interface Timing Characteristics

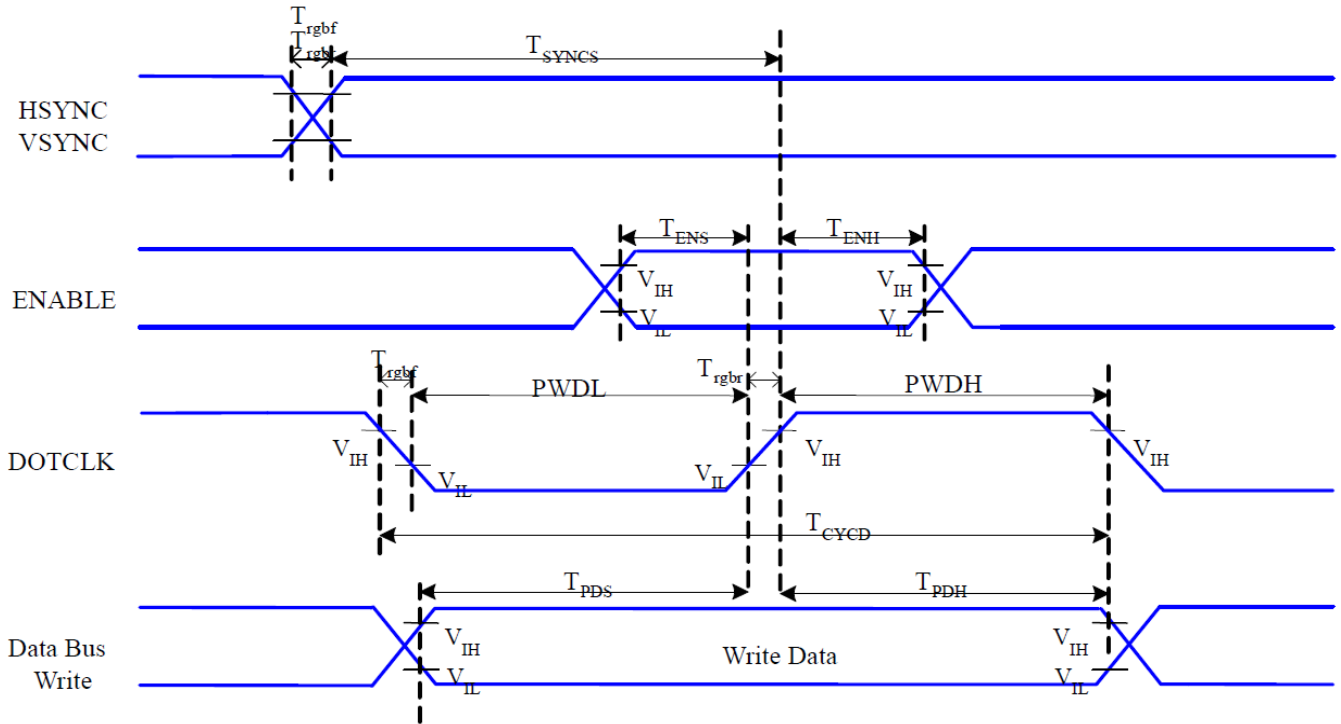


Figure6-4-1 RGB Interface Timing Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 °C

Signal	Symbol	Parameter	Min	Max	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYNC, HSYNC Setup Time	30		ns	
ENABLE	T_{ENS}	Enable Setup Time	25		ns	
	T_{ENH}	Enable Hold Time	25		ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	60		ns	
	PWDL	DOTCLK Low-level Pulse Width	60		ns	
	T_{CYCD}	DOTCLK Cycle Time	120		ns	
	T_{rghr} T_{rghf}	DOTCLK Rise/Fall time		20	ns	
DB	T_{PDS}	PD Data Setup Time	50		ns	
	T_{PDH}	PD Data Hold Time	50		ns	

Table6-4-1 18/16 Bits RGB Interface Timing Characteristics

7.5 Reset Timing Characteristics

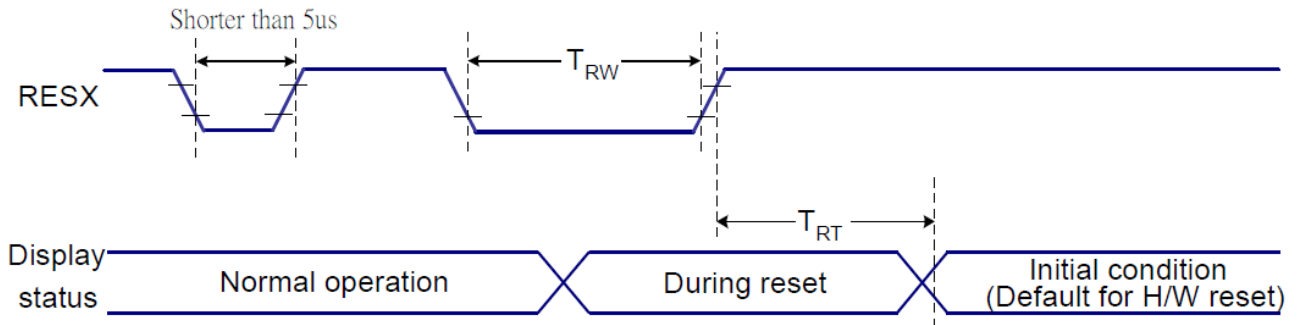


Figure6-5-1 Reset Timing

$V_{DD1}=1.65$ to $3.3V$, $V_{DD}=2.4$ to $3.3V$, $AGND=DGND=0V$, $T_a=-30$ to $70\text{ }^{\circ}\text{C}$

Signal	Symbol	Parameter	Min	Max	Unit
RESX	T_{RW}	Reset pulse duration	10		us
	T_{RT}	Reset cancel		5 (Note 1, 5) 120 (Note 1, 6, 7)	ms ms

Notes:

- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.
- Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
- Spike Rejection also applies during a valid reset pulse as shown below:

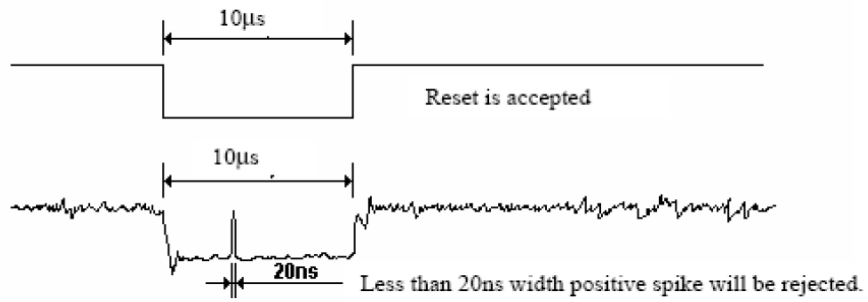
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NO MOQ

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5. When Reset applied during Sleep In Mode.

6. When Reset applied during Sleep Out Mode.

7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

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NO MOQ

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8 LCD Module Out-Going Quality Level

8.1 VISUAL & FUNCTION INSPECTION STANDARD

8.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

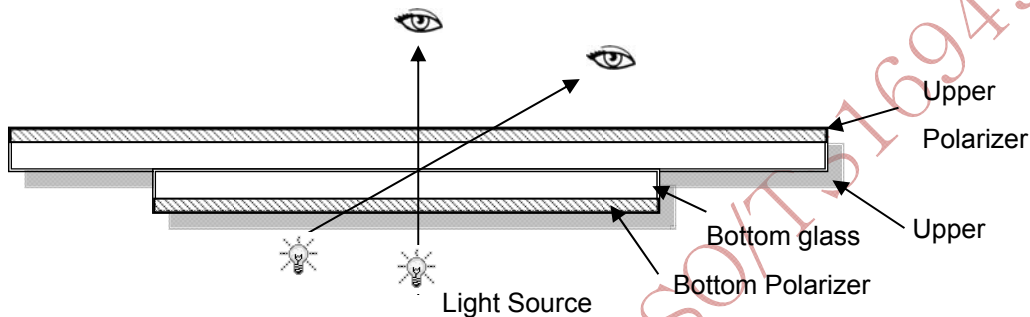
Temperature : 25±5℃

Humidity : 65%±10%RH

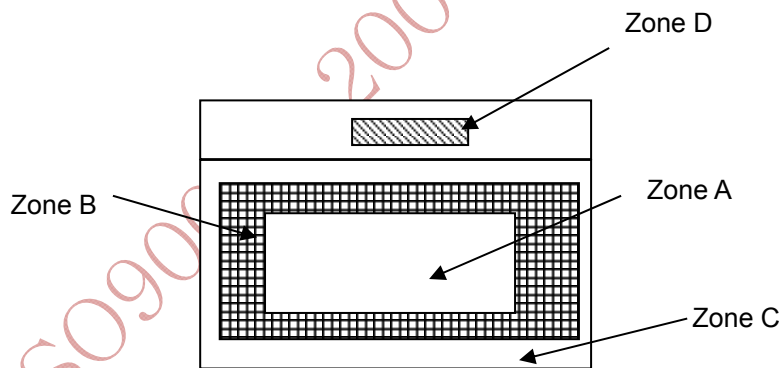
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



8.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Zone D : IC Bonding Area

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

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8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot Line defect	Light dot, Dim spot, Polarizer Bubble ; Polarizer accidented spot.	
6	Soldering appearance	Good soldering , Peeling off is not allowed.	
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

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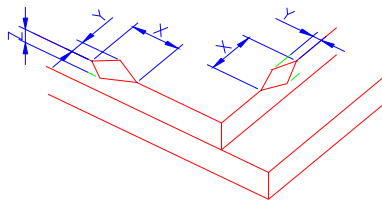
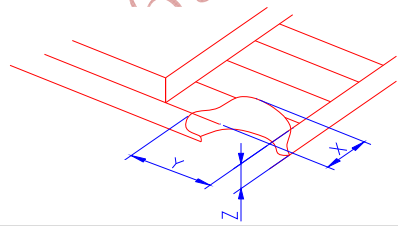
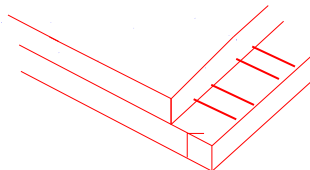
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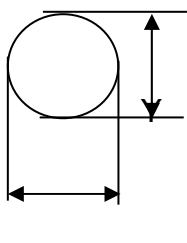
8.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	 <table border="1" data-bbox="758 667 1455 817"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤3.0mm</td> <td><Inner border line of the seal</td> <td>≤T</td> </tr> </tbody> </table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
X	Y	Z						
≤3.0mm	<Inner border line of the seal	≤T						
	(2)LCD corner broken	 <table border="1" data-bbox="833 1124 1375 1223"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤3.0mm</td> <td>≤L</td> <td>≤T</td> </tr> </tbody> </table>	X	Y	Z	≤3.0mm	≤L	≤T
X	Y	Z						
≤3.0mm	≤L	≤T						
	(3) LCD crack	 <p style="text-align: center;">Crack Not allowed</p>						



2.0

Spot defect



X

$$\Phi = (X+Y)/2$$

① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.10$	Ignore		
$0.10 < \Phi \leq 0.25$	3(distance $\geq 10\text{mm}$)		
$0.25 < \Phi \leq 0.3$	2		
$\Phi > 0.35$	0		

② Dim spot (LCD/TP/Polarizer dim dot, light leakage, dark spot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.1$	Ignore		
$0.10 < \Phi \leq 0.25$	3(distance $\geq 10\text{mm}$)		
$0.25 < \Phi \leq 0.3$	2		
$\Phi > 0.35$	0		

③ Polarizer accidented spot

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.2$	Ignore		
$0.3 < \Phi \leq 0.5$	2(distance $\geq 10\text{mm}$)		
$\Phi > 0.5$	0		

④ Pixel bad points (light dot, Dim dot, color dot)

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.1$	Ignore		
$0.15 < \Phi \leq 0.25$	2(distance $\geq 10\text{mm}$)		
$\Phi > 0.3$	0		

⑤ Polarizer Bubble

Zone Size (mm)	Acceptable Qty		
	A	B	C
$\Phi \leq 0.2$	Ignore		
$0.3 < \Phi \leq 0.4$	3(distance $\geq 10\text{mm}$)		
$0.4 < \Phi \leq 0.5$	2		
$\Phi > 0.5$	0		

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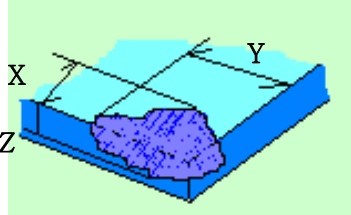
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NO MOQ

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3.0	Line defect (LCD/TP /Polarizer backlight black/white line, scratch, stain)	Width(mm)	Length(m)	Acceptable Qty		
				A	B	C
		$\Phi \leq 0.05$	Ignore	Ignore		
		$0.05 < W \leq 0.06$	$L \leq 3.0$	N \leq 2		
		$0.07 < W \leq 0.08$	$L \leq 2.0$	N \leq 1		
	$0.08 < W$	Define as spot defect				
4.0	Electronic Components SMT	Not allow missing parts, solderless connection, cold solder joint, mismatch, The positive and negative polarity opposite				
5.0	Display color & Brightness	<p>1. Color : Measuring the color coordinates, The measurement standard according to the datasheet or samples.</p> <p>2. Brightness : Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.</p>				

6.0	TP Related	TP film bubble/ accidented spot	Size Φ (mm)	Acceptable Qty			
				A	B	C	
			$\Phi \leq 0.1$	Ignore			
			$0.1 < \Phi \leq 0.2$	3 (distance \geq 10mm)			
			$0.25 < \Phi \leq 0.3$	2			
			$\Phi > 0.35$	0			
		TP film scratch	Width(mm)	Length(mm)	Acceptable Qty		
					A	B	C
			$\Phi \leq 0.05$	Ignore	Ignore		
			$0.05 < W \leq 0.06$	$L \leq 3.0$	N \leq 2		
$0.07 < W \leq 0.08$	$L \leq 2.0$		N \leq 1				
	$0.08 < W$	Define as spot defect					

		<p>Assembly deflection</p>	<p>beyond the edge of backlight $\leq 0.2\text{mm}$</p>							
		<p>Bulge (undulation included)</p>	<p>The ITO film plumped below 0.40mm, it's ok.</p>							
		<p>Newton Ring</p>	<p>Newton Ring area $> 1/3$ TP area NG Newton Ring area $\leq 1/3$ TP area OK</p>							
		<p>TP corner broken X : length Y : width Z : height</p>	<table border="1" data-bbox="646 1489 1109 1635"> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>$X \leq 3\text{mm}$</td> <td>$Y \leq 3\text{mm}$</td> <td>$Z < \text{COVER thickness}$</td> </tr> </table> <p>* *Circuitry broken is not allowed.</p>	X	Y	Z	$X \leq 3\text{mm}$	$Y \leq 3\text{mm}$	$Z < \text{COVER thickness}$	
X	Y	Z								
$X \leq 3\text{mm}$	$Y \leq 3\text{mm}$	$Z < \text{COVER thickness}$								



		TP edge broken X : length Y : width Z : height	X	Y	Z	
			X≤4mm	Y≤2mm	Z<COVER thickness	
			* Circuitry broken is not allowed.			

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

ISO9001 : 2008

ISO/TS16949 : 2009

9. Reliability Test Result

9.1 Condition

Item	Condition	Sample Size	Test Result	Note
Low Temperature Operating Life test	-20°C, 96HR	3ea	pass	-
Thermal Humidity Operating Life test	70°C90%RH, 96HR	3ea	pass	-
Temperature Cycle ON/OFF test	-20°C ↔ 70°C, ON/OFF, 20CYC	3ea	pass	(1)
High Temperature Storage test	80°C, 96HR	3ea	pass	-
Low Temperature Storage test	- 30°C, 96HR	3ea	pass	-
ESD test	150pF, 330Ω, ±6KV(Contact)/± 8KV(Air), 5 points/panel, 10 times/point	3ea	pass	
Thermal Shock Resistance	The sample should be allowed to stand the following 5 cycles of operation: TSTL for 30 minutes -> normal temperature for 5 minutes -> TSTH for 30 minutes -> normal temperature for 5 minutes, as one cycle, then taking it out and drying it at normal temperature, and allowing it stand for 24 hours	3ea	pass	
Box Drop Test	1 Corner 3 Edges 6 faces, 66cm(MEDIUM BOX)	1box	pass	-

Note (1) ON Time over 10 seconds, OFF Time under 10 seconds

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支持少量
NO MOQ

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10. Cautions and Handling Precautions

10.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

10.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

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11. Packing

---TBD-----

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